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☒ Assignment ☐ Merger  
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Execution Date(s): June 12, 2008
4. Application number(s) or patent number(s):  
☐ This document is being filed together with a new application:  
(a) The execution date(s) of the application is/are:  
(b) The title is: THIN FILM TRANSISTOR, METHOD OF FABRICATING THE THIN FILM TRANSISTOR, AND DISPLAY DEVICE INCLUDING THE THIN FILM TRANSISTOR  
OR  
☒ This document is being filed after filing of the application:  
(a) Patent Application No(s). 12/138,884, filed June 13, 2008; or  
(b) Patent No(s). , issued .
5. Name and address of party to whom correspondence concerning document should be mailed:  
STEIN, MCEWEN & BUI, LLP Our Docket: 0041.1038  
Attention: Michael D. Stein  
1400 Eye St., N.W., Suite 300  
Washington, D.C. 20005
6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)  
☒ Enclosed  
☐ Authorized to be charged to Deposit Account No. 503333.
8. Deposit Account No. 503333: (Any underpayment is authorized to be charged to this Deposit Account) (Attach duplicate copy of this page if paying by deposit account)

Michael D. Stein , Reg. No. 37,240  
Name of Person Signing

Signature

Date

Total number of pages including cover sheet: 2

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# U.S. ASSIGNMENT

SMB 12/04

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

**SAMSUNG SDI CO., LTD.**  
575, Shin-dong, Yeongtong-gu  
Suwon-si, Gyeonggi-do  
Republic of Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled  
(Title of Invention)

## THIN FILM TRANSISTOR, METHOD OF FABRICATING THE THIN FILM TRANSISTOR, AND DISPLAY DEVICE INCLUDING THE THIN FILM TRANSISTOR

relating to International Patent Application PCT/JP\_\_\_\_\_/\_\_\_\_\_, and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on ; (Insert date of execution of application, if not concurrent)

(b) filed on ,

Application No. Not yet assigned;

Any registered attorney of STEIN, MCEWEN & BUI, LLP, 1400 Eye St., N.W., Suite 300, Washington, D.C. 20005 (202/216-9505) is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Typed Name & Signature of Witness(es))

1)	<u>Tae Hoon Yang</u> Tae-Hoon YANG	<u>June 12, 2008</u>	_____
2)	<u>Ki-Yong Lee</u> Ki-Yong LEE	<u>June 12, 2008</u>	_____
3)	<u>JinWook Seo</u> Jin-Wook SEO	<u>June 12, 2008</u>	_____
4)	<u>Byoung Keon Park</u> Byoung-Keon PARK	<u>June 12, 2008</u>	_____
5)	_____	_____	_____

PATENT

RECORDED: 06/17/2008

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